

Customer Information Notification

Issue Date: 24-Jun-2015 Effective Date: 31-Jul-2015

Here's your personalized quality information concerning products Digi-Key purchased from NXP.

For detailed information we invite you to view this notification online

2015060071



Management Summary

Data sheet update for PMEG2005BELD and PMEG2010BELD.

Change Category

] Wafer Fab process	[] Assembly Process	[] Product Marking	[] Design

[] Wafer Fab materials [] Assembly Materials [X] Electrical spec./Test coverage [] Mechanical Specification [] Wafer Fab location [] Assembly Location [] Test Location [] Packing/Shipping/Labeling

Data sheet update for PMEG2005BELD and PMEG2010BELD

Information Notification

Image of binary marking code description in the data sheet will be updated.

Reason for change: Standardization and editorial correction of binary marking code image.

Impact of change: Products and product marking remain unchanged. Only the marking image in the data sheet is updated. There is no change on electrical parameters or external dimensions.

Why do we issue this Information Notification

Data sheet update

Identification of Affected Products

Product identification does not change

Impact

no impact to the product's functionality anticipated.

Data Sheet Revision

A new datasheet will be issued

Contact and Support

For all inquiries regarding the ePCN tool application or access issues, please contact NXP "Global Quality Support Team".

For all Quality Notification content inquiries, please contact your local NXP Sales Support team.

For specific questions on this notice or the products affected please contact our specialist directly:

Name GA Customer Support

e-mail address DiscrQA.Helpdesk.GA-Products@nxp.com

At NXP Semiconductors we are constantly striving to improve our product and processes to ensure they reach the highest possible Quality Standards.

Customer Focus, Passion to Win.

NXP Quality Management Team.

About NXP Semiconductors

NXP Semiconductors N.V. (NASDAQ: NXPI) provides High Performance Mixed Signal and Standard Product solutions that leverage its leading RF, Analog, Power Management, Interface, Security and Digital Processing expertise. These innovations are used in a wide range of automotive, identification, wireless infrastructure, lighting, industrial, mobile, consumer and computing applications.

You have received this email because you are a designated contact or subscribed to NXP's Quallity Notifications. NXP shall not be held liable if this Notification is not correctly distributed within your organization.

This message has been automatically distributed. Please do not reply.

View Notification	Subscription	Support
-------------------	--------------	---------

NXP | Privacy Policy | Terms of Use

NXP Semiconductors

High Tech Campus, 5656 AG Eindhoven, The Netherlands

© 2006-2010 NXP Semiconductors. All rights reserved.